

## 1. General description

High voltage, high speed, planar passivated NPN power switching transistor in a SOT54 (TO-92) plastic package.

## 2. Features and benefits

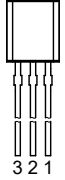
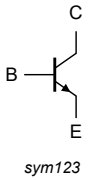
- Fast switching
- High voltage capability
- Very low switching and conduction losses

## 3. Applications

- Compact fluorescent lamps (CFL)
- Electronic lighting ballasts
- Inverters
- Off-line self-oscillating power supplies

## 4. Pinning information

Table 1. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	B	base	 <p>TO-92 (SOT54)</p>	 <p>sym123</p>
2	C	collector		
3	E	emitter		

## 5. Ordering information

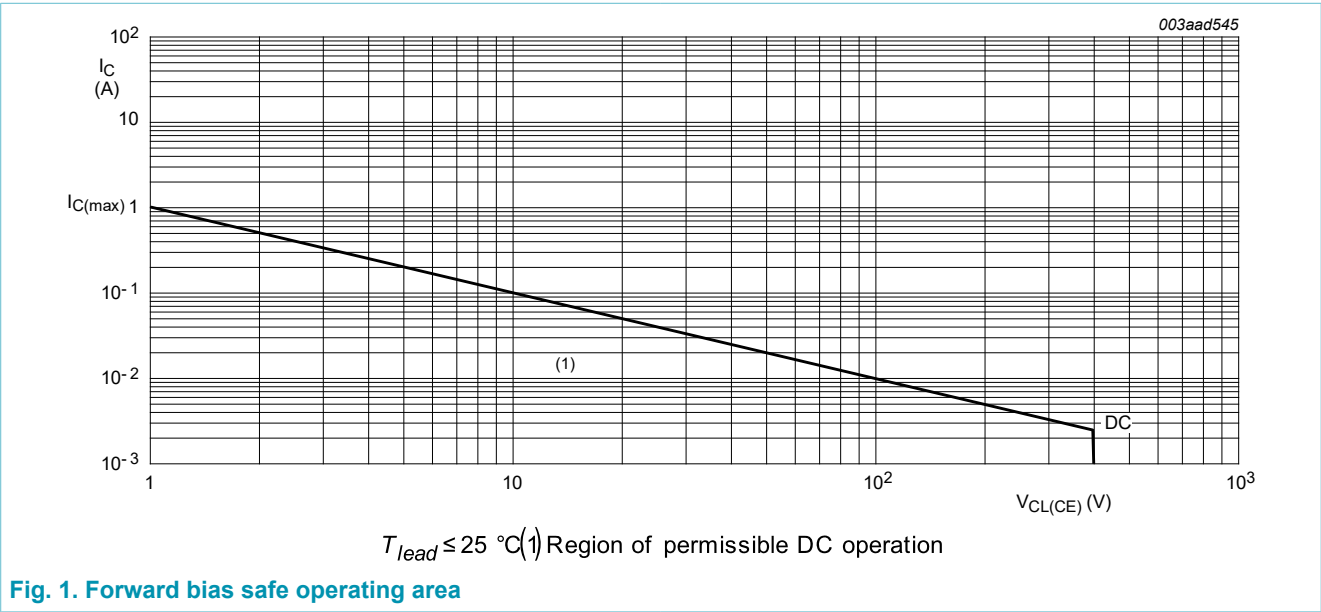
Table 2. Ordering information

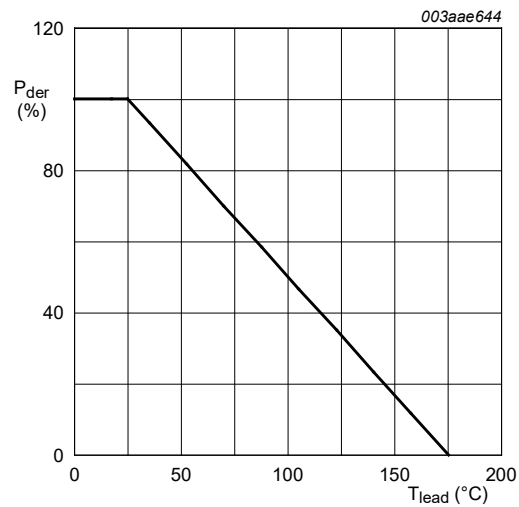
Type number	Package		
	Name	Description	Version
BUJ100LR	TO-92	plastic single-ended leaded (through hole) package; 3 leads	SOT54

6. Limiting values

Table 3. Limiting values  
In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
$V_{CESM}$	collector-emitter peak voltage	$V_{BE} = 0\text{ V}$	-	700	V
$V_{CBO}$	collector-base voltage	$I_E = 0\text{ A}$	-	700	V
$V_{CEO}$	collector-emitter voltage	$I_B = 0\text{ A}$	-	400	V
$V_{EBO}$	emitter-base voltage	$I_C = 0\text{ A}; I(\text{Emitter}) = 10\text{ mA}$	-	9	V
$I_C$	collector current	DC; Fig. 1	-	1	A
$I_{CM}$	peak collector current		-	2	A
$I_B$	base current	DC	-	0.5	A
$I_{BM}$	peak base current		-	1	A
$P_{tot}$	total power dissipation	$T_{lead} \leq 25\text{ }^{\circ}\text{C}$ ; Fig. 2	-	2.1	W
$T_{stg}$	storage temperature		-65	150	$^{\circ}\text{C}$
$T_j$	junction temperature		-	150	$^{\circ}\text{C}$





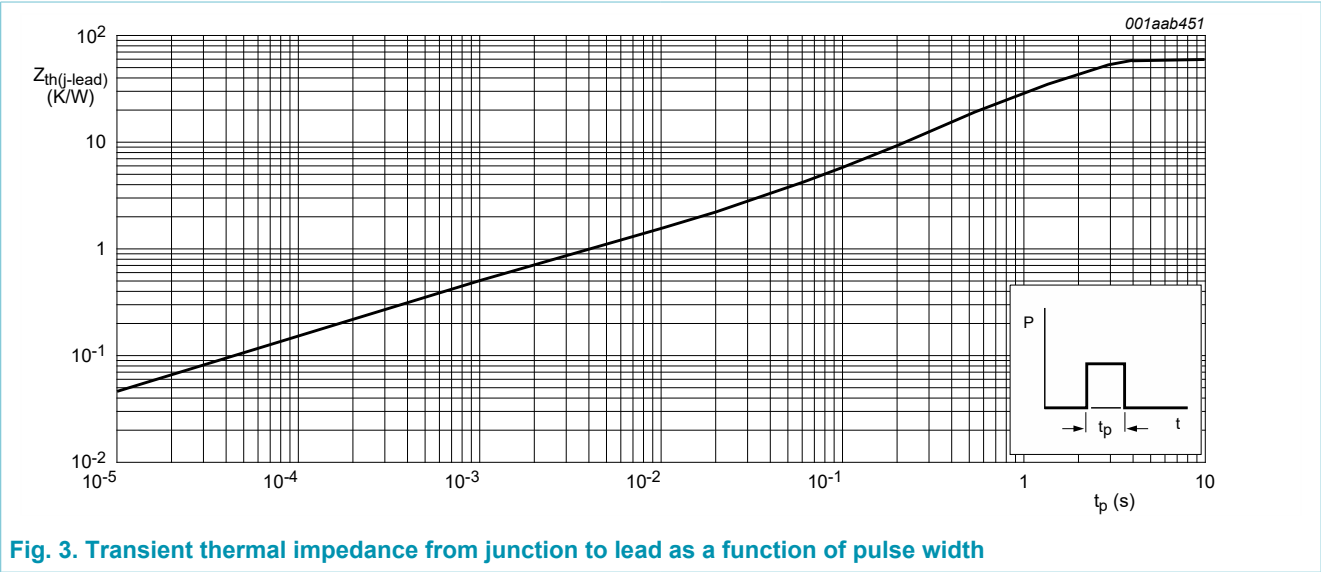
$$P_{der} = \frac{P_{tot}}{P_{tot(25^{\circ}C)}} \times 100\%$$

Fig. 2. Normalized total power dissipation as a function of lead temperature

7. Thermal characteristics

Table 4. Thermal characteristics

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
$R_{th(j-lead)}$	thermal resistance from junction to lead	<a href="#">Fig. 3</a>	-	-	60	K/W
$R_{th(j-a)}$	thermal resistance from junction to ambient free air	printed circuit board mounted; lead length 4 mm	-	150	-	K/W



8. Characteristics

Table 5. Characteristics

Symbol	Parameter	Conditions		Min	Typ	Max	Unit
Static characteristics							
I <sub>CES</sub>	collector-emitter cut-off current (base shorted)	V <sub>BE</sub> = 0 V; V <sub>CE</sub> = 700 V; T <sub>j</sub> = 125 °C		-	-	5	mA
I <sub>EBO</sub>	emitter-base cut-off current (collector open)	V <sub>EB</sub> = 9 V; I <sub>C</sub> = 0 A; T <sub>lead</sub> = 25 °C		-	-	1	mA
V <sub>CEOsus</sub>	collector-emitter sustaining voltage (base open)	I <sub>B</sub> = 0 A; I <sub>C</sub> = 1 mA; L <sub>C</sub> = 25 mH; T <sub>lead</sub> = 25 °C; <a href="#">Fig. 4</a> ; <a href="#">Fig. 5</a>		400	-	-	V
V <sub>CEsat</sub>	collector-emitter saturation voltage	I <sub>C</sub> = 0.25 A; I <sub>B</sub> = 50 mA; T <sub>lead</sub> = 25 °C; <a href="#">Fig. 6</a>		-	0.2	0.5	V
		I <sub>C</sub> = 0.5 A; I <sub>B</sub> = 125 mA; T <sub>lead</sub> = 25 °C; <a href="#">Fig. 6</a>		-	0.3	1	V
		I <sub>C</sub> = 0.75 A; I <sub>B</sub> = 250 mA; T <sub>lead</sub> = 25 °C; <a href="#">Fig. 6</a>		-	0.4	1.5	V
V <sub>BEsat</sub>	base-emitter saturation voltage	I <sub>C</sub> = 0.25 A; I <sub>B</sub> = 50 mA; T <sub>lead</sub> = 25 °C; <a href="#">Fig. 7</a>		-	-	1	V
		I <sub>C</sub> = 0.5 A; I <sub>B</sub> = 125 mA; T <sub>lead</sub> = 25 °C; <a href="#">Fig. 7</a>		-	-	1.2	V
h <sub>FE</sub>	DC current gain	I <sub>C</sub> = 0.5 mA; V <sub>CE</sub> = 2 V; T <sub>lead</sub> = 25 °C		12	-	-	
		I <sub>C</sub> = 0.4 A; V <sub>CE</sub> = 5 V; T <sub>lead</sub> = 25 °C; <a href="#">Fig. 8</a> ; <a href="#">Fig. 9</a>		10	-	30	
		I <sub>C</sub> = 0.8 A; V <sub>CE</sub> = 5 V; T <sub>lead</sub> = 25 °C; <a href="#">Fig. 8</a> ; <a href="#">Fig. 9</a>		5	7.5	20	
Dynamic characteristics							
t <sub>f</sub>	fall time	I <sub>C</sub> = 1 A; I <sub>Bon</sub> = 200 mA; V <sub>BB</sub> = -5 V; L <sub>B</sub> = 1 μH; T <sub>lead</sub> = 25 °C; inductive load; <a href="#">Fig. 10</a> ; <a href="#">Fig. 11</a>		-	80	-	ns

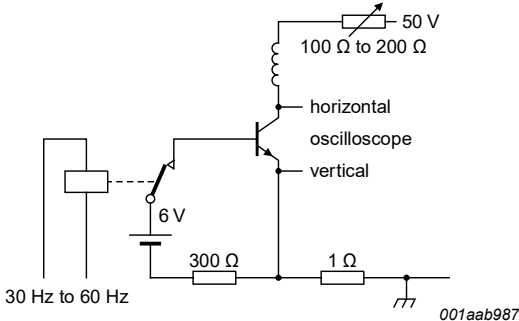


Fig. 4. Test circuit for collector-emitter sustaining voltage

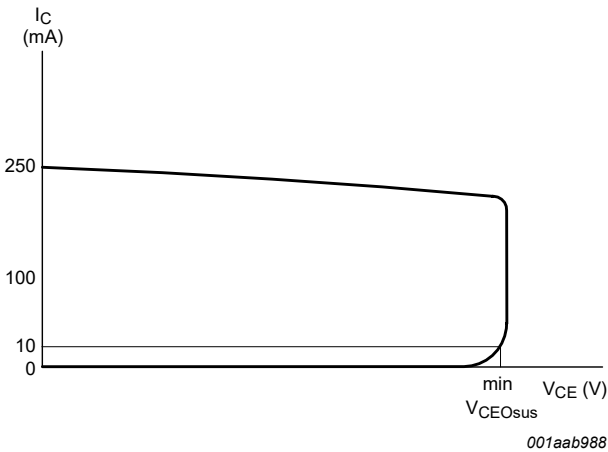


Fig. 5. Oscilloscope display for collector-emitter sustaining voltage test waveform

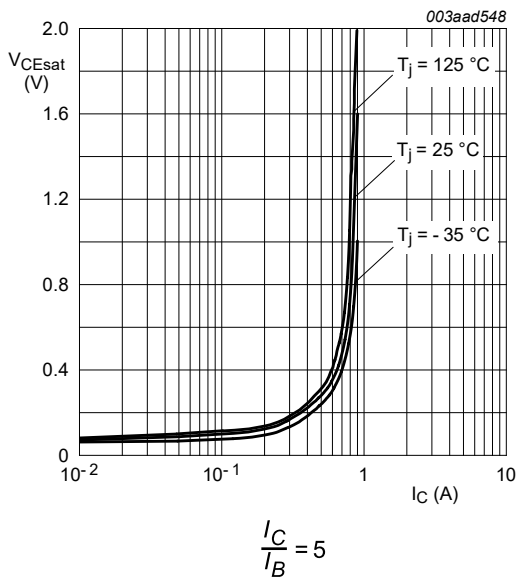


Fig. 6. Collector-emitter saturation voltage as a function of collector current; typical values

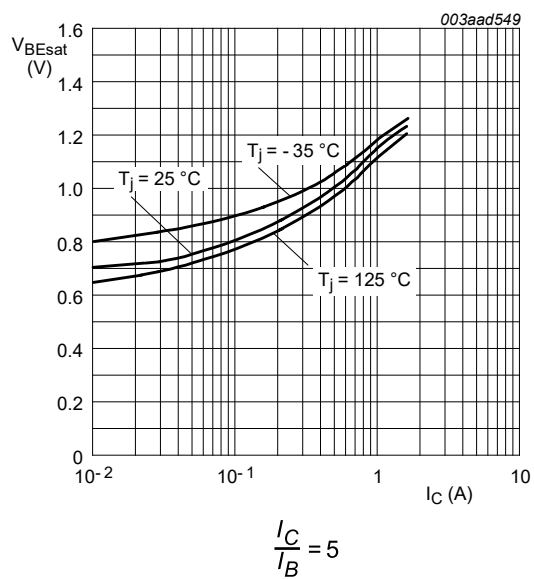


Fig. 7. Base-emitter saturation voltage as a function of collector current; typical values

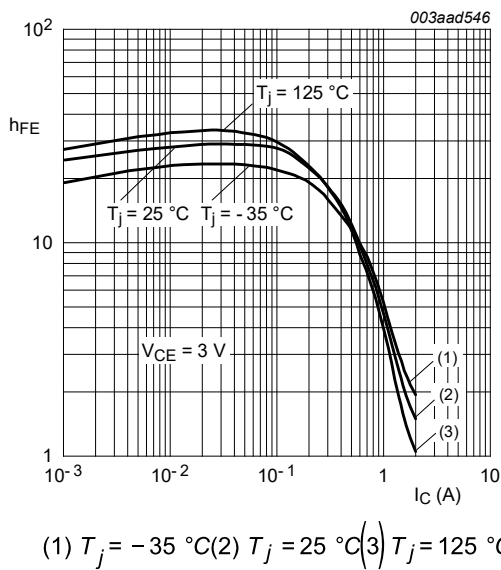


Fig. 8. DC current gain as a function of collector current; typical values

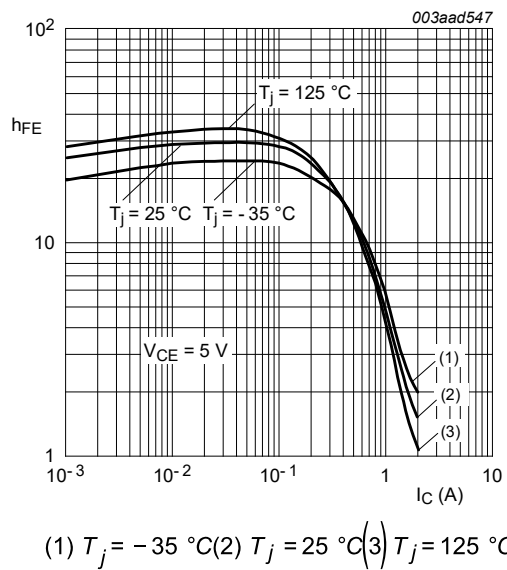


Fig. 9. DC current gain as a function of collector current; typical values

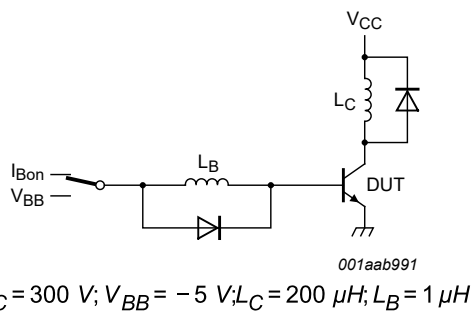


Fig. 10. Test circuit for inductive load switching

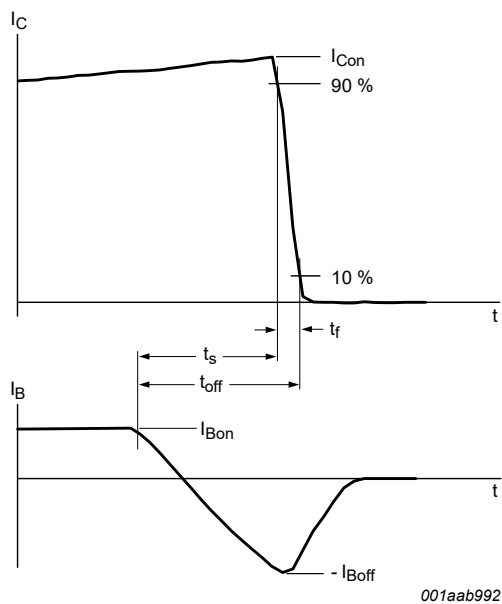


Fig. 11. Switching times waveforms for inductive load

9. Package outline

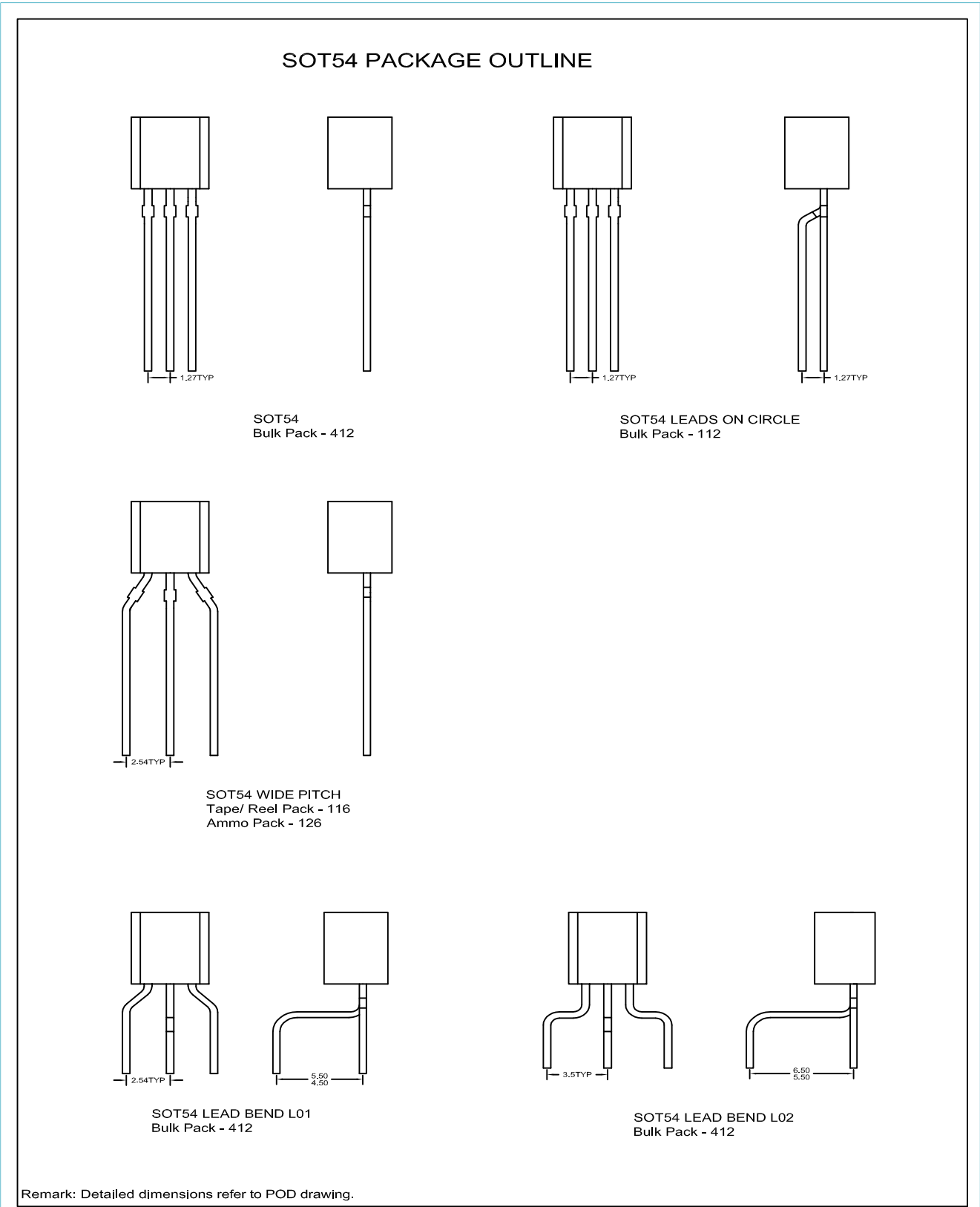


Fig. 12. Package outline TO-92 (SOT54)



## 10. Legal information

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Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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